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3GPP2 CORRESPONDENCE

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March 31, 2006

Mr. Alain BIBAS (Orange)
Chair, 3GPP TSG-SA5 SWGB Charging
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Re: Response to "LS on OMA Specific Diameter Application"

Dear Alain:

TSG-X wishes to thank SWGB for copying us on your liaison letter (S5-064373) to OMA. As TSG-X is responsible for 3GPP2 specifications for IMS related Diameter based charging, we thought we should comment on the proposed CR attached to your liaison.

It is the view of TSG-X that it would be best if we didn't have to update our protocols each time OMA, or another group, defines a new application to be used over IMS. We realize that the same charging collection function may need to interact with multiple applications and may need to gather different information from each of these. Thus it may not be possible to maintain a single protocol for the interfaces used to support OMA.

This being the case, 3GPP2 would prefer that OMA enabler-specific AVPs be developed in OMA rather than in 3GPP. We would ask that your group, and OMA, take these views into account in determining the resolution to the above-mentioned CR.

Regards,

Betsy Covell
Chair, 3GPP2 TSG-X

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